

AM2520SF4C03

Infrared Emitting Diode



DESCRIPTION

• SF4 Made with Gallium Aluminum Arsenide Infrared Emitting diodes

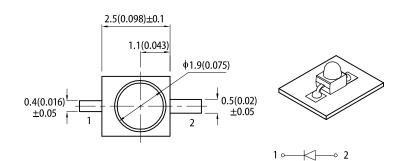
FEATURES

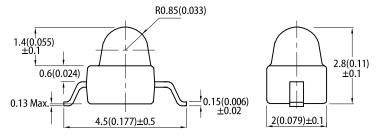
- Subminiature package
- · Mechanically and spectrally matched to the phototransistor
- · Gull wing lead
- · Long life solid state reliability
- · Low package profile
- Package matches with photodetector AM2520PD1BT03
- Package: 1000 pcs / reel
- Moisture sensitivity level: 3
- Halogen-free
- RoHS compliant

APPLICATIONS

- · Infrared Illumination for cameras
- Machine vision systems
- · Surveillance systems
- · Industrial electronics
- IR data transmission
- · Remote control

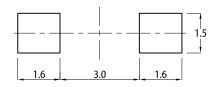
PACKAGE DIMENSIONS





RECOMMENDED SOLDERING PATTERN

(units: mm; tolerance: \pm 0.1)



- Notes:

 1. All dimensions are in millimeters (inches).

 2. Tolerance is ±0.25(0.01") unless otherwise noted.

 3. The specifications, characteristics and technical data described in the datasheet are subject to change without prior notice.

 4. The device has a single mounting surface. The device must be mounted according to the specifications.

SELECTION GUIDE

| Part Number | Emitting Color (Material) | Lens Type | Po (mW/sr) @ 20mA [2] | | Po (mW/sr) @ 50mA [2] | | Viewing Angle [1] |
|--------------|------------------------------|-------------|-----------------------|------|-----------------------|------|-------------------|
| | | | Min. | Тур. | Min. | Тур. | 201/2 |
| AM2520SF4C03 | Infrared (GaAlAs) | Water Clear | 2 | 4 | 3 | 8 | 20° |

Notes.

1. 61/2 is the angle from optical centerline where the luminous intensity is 1/2 of the optical peak value.

2. Radiant Intensity / luminous flux: +/-15%.

3. Radiant intensity value is traceable to CIE127-2007 standards.





ELECTRICAL / OPTICAL CHARACTERISTICS at T_A=25°C

| Parameter | Symbol | Emitting Color | Value | | Unit |
|--|-------------------------------|----------------|-------|------|------|
| raiametei | | Emitting Color | Тур. | Max. | Onit |
| Wavelength at Peak Emission I _F = 20mA | λ_{peak} | Infrared | 880 | - | nm |
| Spectral Bandwidth at 50% Φ REL MAX $I_F = 20$ mA | Δλ | Infrared | 50 | - | nm |
| Forward Voltage I _F = 20mA | V _F ^[1] | Infrared | 1.3 | 1.6 | V |
| Reverse Current (V _R = 5V) | I _R | Infrared | - | 10 | μА |

ABSOLUTE MAXIMUM RATINGS at T_A=25°C

| Parameter | Symbol | Value | Unit | | | |
|---|--------------------------------|------------|------|--|--|--|
| Power Dissipation | P _D | 85 | mW | | | |
| Reverse Voltage | V _R | 5 | V | | | |
| Junction Temperature | T _j | 125 | °C | | | |
| Operating Temperature | T _{op} | -40 to +85 | °C | | | |
| Storage Temperature | T _{stg} | -40 to +85 | °C | | | |
| DC Forward Current | I _F | 50 | mA | | | |
| Peak Forward Current | I _{FP} ^[1] | 1200 | mA | | | |
| Electrostatic Discharge Threshold (HBM) | - | 8000 | V | | | |

Notes:
1. 1/100 Duty Cycle, 10µs Pulse Width.
2. Relative humidity levels maintained between 40% and 60% in production area are recommended to avoid the build-up of static electricity – Ref JEDEC/JESD625-A and JEDEC/J-STD-033.

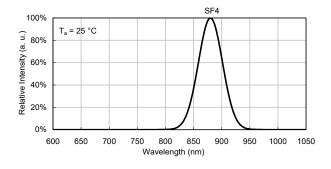


^{1.} Forward voltage: ±0.1V.
2. Wavelength value is traceable to CIE127-2007 standards.
3. Excess driving current and / or operating temperature higher than recommended conditions may result in severe light degradation or premature failure.

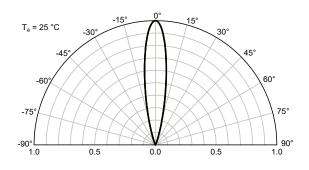


TECHNICAL DATA

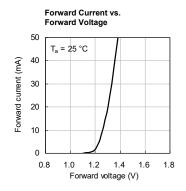
RELATIVE INTENSITY vs. WAVELENGTH

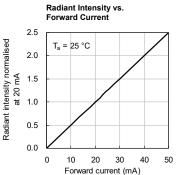


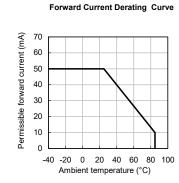
SPATIAL DISTRIBUTION

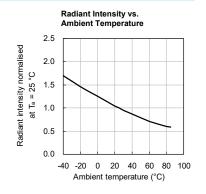


INFRARED

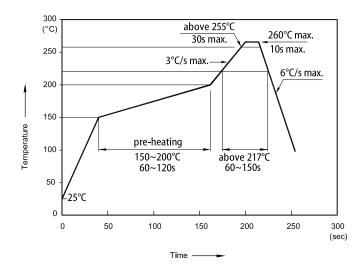








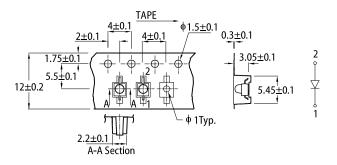
REFLOW SOLDERING PROFILE for LEAD-FREE SMD PROCESS



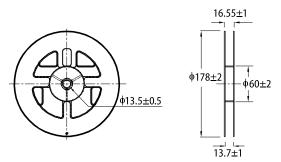
Notes

- 1. Don't cause stress to the LEDs while it is exposed to high temperature.
 2. The maximum number of reflow soldering passes is 2 times.
 3. Reflow soldering is recommended. Other soldering methods are not recommended as they might

TAPE SPECIFICATIONS (units:mm)



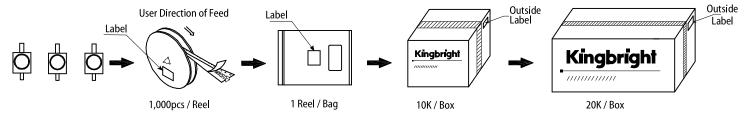
REEL DIMENSION (units: mm)

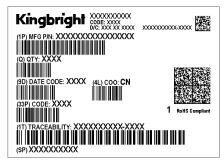






PACKING & LABEL SPECIFICATIONS





PRECAUTIONARY NOTES

- The information included in this document reflects representative usage scenarios and is intended for technical reference only.
- The part number, type, and specifications mentioned in this document are subject to future change and improvement without notice. Before production usage customer should refer to the latest datasheet for the updated specifications.
- When using the products referenced in this document, please make sure the product is being operated within the environmental and electrical limits specified in the datasheet. If
- when using the products reference in this document, please make sure the product is being operated within the environmental and electrical limits, specified limits, Kingbright will not be responsible for any subsequent issues.

 The information in this document applies to typical usage in consumer electronics applications. If customer's application has special reliability requirements or have life-threatening liabilities, such as automotive or medical usage, please consult with Kingbright representative for further assistance.

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